L Number	Hits	Search Text		Time stamp
1	2	"5408053" .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:55
2	0	transmission with diferent with dielectric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:56
3	0	diferent with dielectric with constant same substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:56
4	673	dielectric with constant same substrate with transmission	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:58
5	673	dielectric with constant same substrate with transmission	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:58
6	469	dielectric with constant same substrate with transmission	USPAT	2003/02/15 16:01
7	22	dielectric with different with constant same substrate with transmission	USPAT	2003/02/15 16:01
54	1758	174/262	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:55
55	809	174/263	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:55
56	669	174/264	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:55
57	651	257/759	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:57
58	409	257/798	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:57
59	9	257/798 and transmission with lines	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:57
60	160	(174/262 174/263 174/264 257/759) and transmission with lines	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 17:58
-	2	6392164.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:02

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–	7	("50390█ | "5408053" | "5450290" | "54593██ | "5473120" | "5734560" | "5835357").PN.	██PAT	2003/02/11 14:26
–	3	("5120384" | "5245136" | "5262595").PN.	USPAT	2003/02/11 15:13
–	2094	(257/758).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:13
–	378	((257/758).CCLS.) and (radius diameter)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:14
–	280	((257/758).CCLS.) and (radius diameter)	USPAT	2003/02/11 15:23
–	9	("5386339" | "5402003" | "5521332" | "5798563" | "5880925" | "6222262" | "6292351" | "6353189" | "6370010").PN.	USPAT	2003/02/11 15:15
–	4	("5195053" | "5219639" | "5512514" | "5869901").PN.	USPAT	2003/02/11 15:18
–	0	1993JP-0206678.ap,prai.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:24
–	2	JP-05206678-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:25
–	1	1993-291906.NRAN.	DERWENT	2003/02/11 15:24
–	473	(MULTILAYER or INTERCONNECTION with BOARD)same (ratio diameter radius) and 257/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:11
–	70	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius) and 257/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:33
–	1285	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 15:33
–	630	((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius)	USPAT	2003/02/11 15:36
–	1677	((MULTILAYER or INTERCONNECTION) with BOARD)and (ratio diameter radius)with (through adj holes holes or vias)	USPAT	2003/02/11 15:55
–	11	("2869040" | "4295184" | "4663840" | "4851614" | "4970624" | "5189261" | "5191174" | "5280414" | "5359767" | "5363280" | "5414223").PN.	USPAT	2003/02/11 15:46
–	8	5736679.URPN.	USPAT	2003/02/11 15:46
–	1289	(((MULTILAYER or INTERCONNECTION) with BOARD)and (ratio diameter radius)with (through adj holes holes or vias)) not (((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius))	USPAT	2003/02/11 16:00
–	924	((((MULTILAYER or INTERCONNECTION) with BOARD)and (ratio diameter radius)with (through adj holes holes or vias)) not (((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius))) and (insulating dielectric)	USPAT	2003/02/11 16:01

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-	781	((((MUL̶T̶I̶LA̶Y̶ER or INTERCONNECTION) with BOARD)and (ratio diameter radius)with (through adj holes holes or vias)) not (((MULTILAYER or INTERCONNECTION) with BOARD)same (ratio diameter radius))) and (ground power)	U̶S̶P̶AT	2003/02/11 16:09
-	9	("3739469" | "4494083" | "4498122" | "4543715" | "5381306" | "5623160" | "5825084" | "6137064" | "6181551").PN.	USPAT	2003/02/11 16:03
-	34	4494083.URPN.	USPAT	2003/02/11 16:07
-	3	5644276.URPN.	USPAT	2003/02/11 16:09
-	14786	impedance same (diameter or radius ratio) and (ground power)	USPAT	2003/02/11 16:11
-	0	(MULTILAYER or INTERCONNECTION with BOARD)and 25.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:11
-	2717	(impedance same (diameter or radius ratio) and (ground power)) and (board PCB)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:12
-	177	((impedance same (diameter or radius ratio) and (ground power)) and (board PCB)) and multilayer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:20
-	0	(174/262.000).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:20
-	974	(174/262).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:21
-	442	((174/262).CCLS.) and (ground power)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/11 16:23
-	541	(439/876).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 17:39
-	3508	transmission with lines same substrate and impedance	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:07
-	0	(transmission with lines same substrate and impedance) and 174.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:03
-	0	174.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:04
-	1	("0000174").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:05

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–	265	(174/2●●CCLS.	PAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:06
–	0	174.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:05
–	0	257.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:05
–	0	257.ccls	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:05
–	6	(transmission with lines same substrate and impedance) and ((174/264).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:07
–	17	transmission with lines and ((174/264).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:09
–	11	(transmission with lines and ((174/264).CCLS.)) not ((transmission with lines same substrate and impedance) and ((174/264).CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:09
–	5	("4494083" | "4673904" | "5012047" | "5499005" | "5644276").PN.	USPAT	2003/02/13 15:08
–	976	(174/262).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:09
––	61	transmission with lines and ((174/262).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:10
–	55	(transmission with lines and ((174/262).CCLS.)) not (transmission with lines and ((174/264).CCLS.))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:13
–	4355	transmission and lines and substrate	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:15
–	881	(transmission and lines and substrate) and ground	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:13
–	15	((transmission and lines and substrate) and ground) and diameter	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:14
–	102	(transmission and lines and substrate) and diameter	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:15
–	111925	transmission with lines	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:15
–	1409	(transmission with lines) and diameter	EPO; JPO; DERWENT; IBM_TDB	2003/02/13 15:16

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–	218	((trans▮▮sion with lines) and diameter) and (i▮▮lating dielectric)	; JPO; ▮▮WENT; IBM_TDB	2003/02/13 15:16
–	34	4494083.URPN.	USPAT	2003/02/13 15:25
–	6	("2422160" | "2938175" | "4494083" | "4816791" | "5093640" | "5994983").PN.	USPAT	2003/02/13 15:28
–	7	("4276558" | "4626805" | "5057798" | "5229727" | "5424693" | "5428327" | "5832598").PN.	USPAT	2003/02/13 15:34
–	3	5994983.URPN.	USPAT	2003/02/13 15:34
–	1	1993JP-0203378.ap,prai.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 10:39
–	1	JP-05203378-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 10:38
–	0	1992JP-013278.ap,prai.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 10:39
–	1	1992JP-0013278.ap,prai.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 11:02
–	1	1993-291906.NRAN.	DERWENT	2003/02/15 10:40
–	2	"6392164" .pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/02/15 15:05

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